**ONE-PIECE INTERFACE FSI SERIES**

**SPECIFICATIONS**

**Materials:**
- Insulator Material: Liquid Crystal Polymer
- Contact Material: Beryllium Copper
- Current Rating: 1A @ 80 ambient
- Operating Temp Range: -65°C to +105°C
- Plating: Au over 50µ" (1.27µm) Ni

**Note:** Some lengths, styles and options are non-standard, non-returnable.

**Processing:**
- Max Processing Temp: 230°C for 60 seconds
- SMT Lead Coplanarity: (0.10mm) .004" max (05-35)
- (0.15mm) .006" max (40-50)

**Suggested PCB Layouts**
Your specific layout may vary

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**Due to technical progress, all designs, specifications and components are subject to change without notice.**